



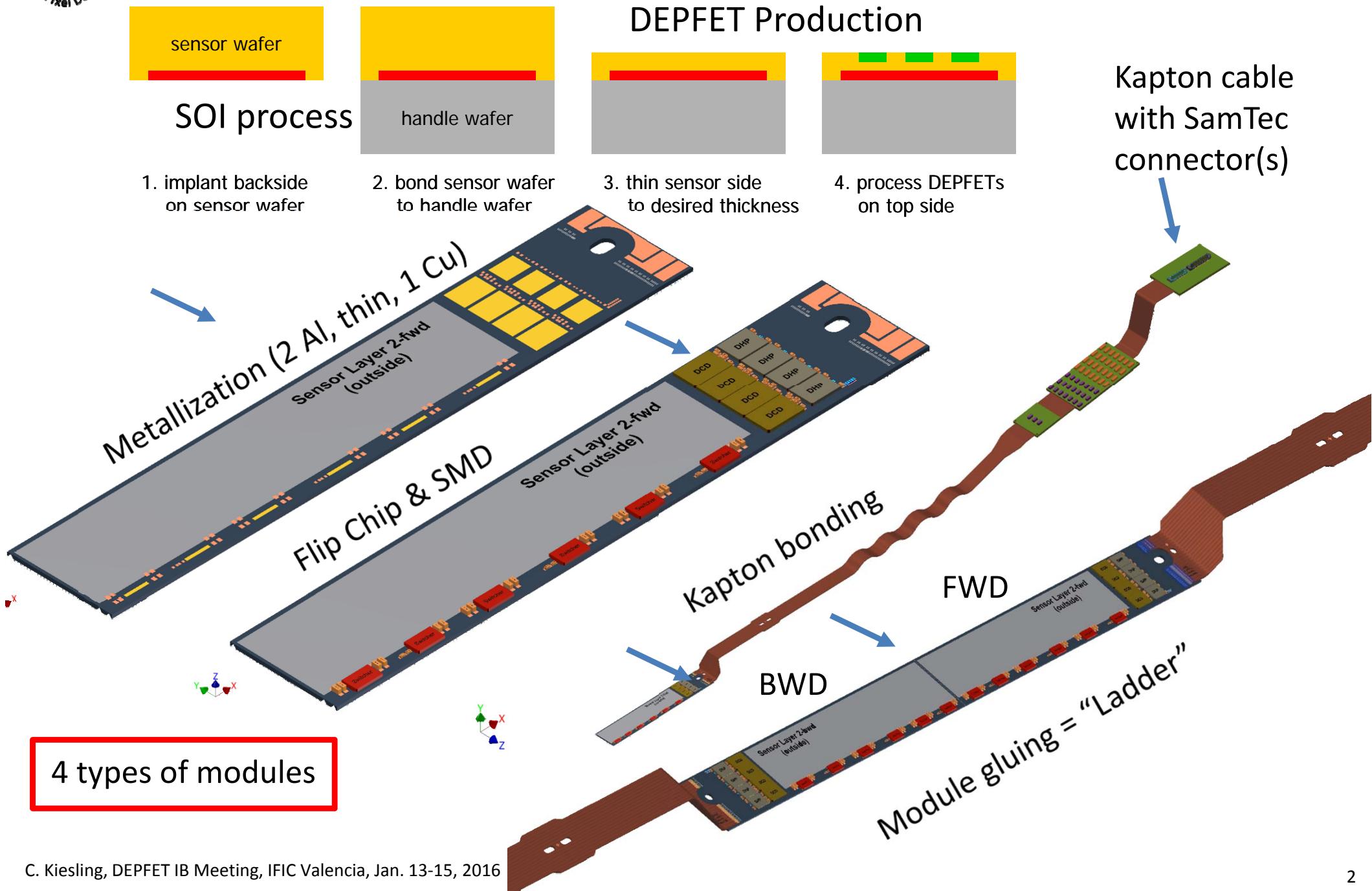
DEPFET IB Meeting

- Report of PL -

- Urgent matters to be discussed/decided during this workshop.
- Discussion on update for the production schedule of the PXD
- Planning of presentations at B2GM / BPAC
- Common Fund status and requests

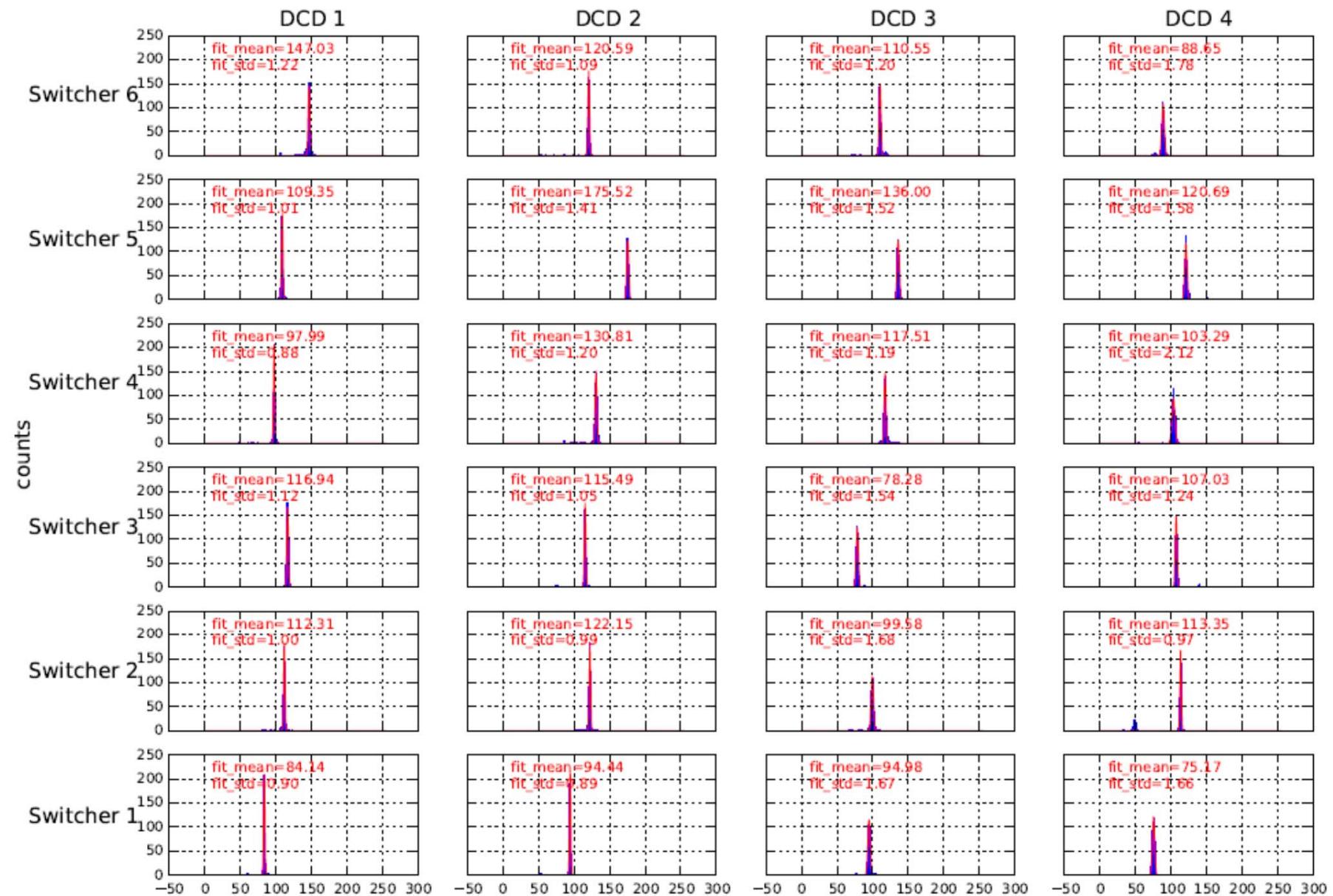


Production Steps of PXD Ladders





PXD Sensors: Ready for Mass Production ?



OB with Kapton

ADU

Laser on single pixel, full speed,
CLEAR OK



PXD Sensors: Ready for Mass Production ?



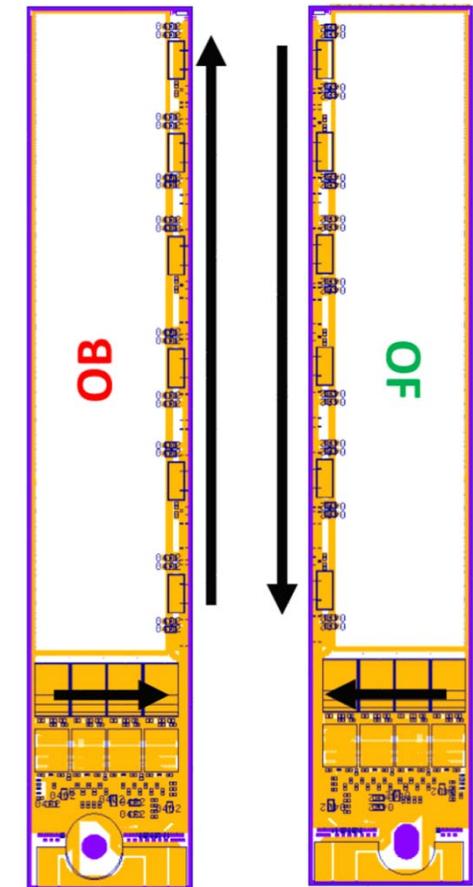
OB with Kapton is working at full speed and complete CLEAR

Should we insist on OF measurements (mounted on hybrid)?
-> There ARE some differences in the metal1 layout.

To be sure, we should continue producing the same plots with (hybrid) OF as for (Kapton) OB [remark: Kapton cable does not introduce any strange effects, seems to work as specified]

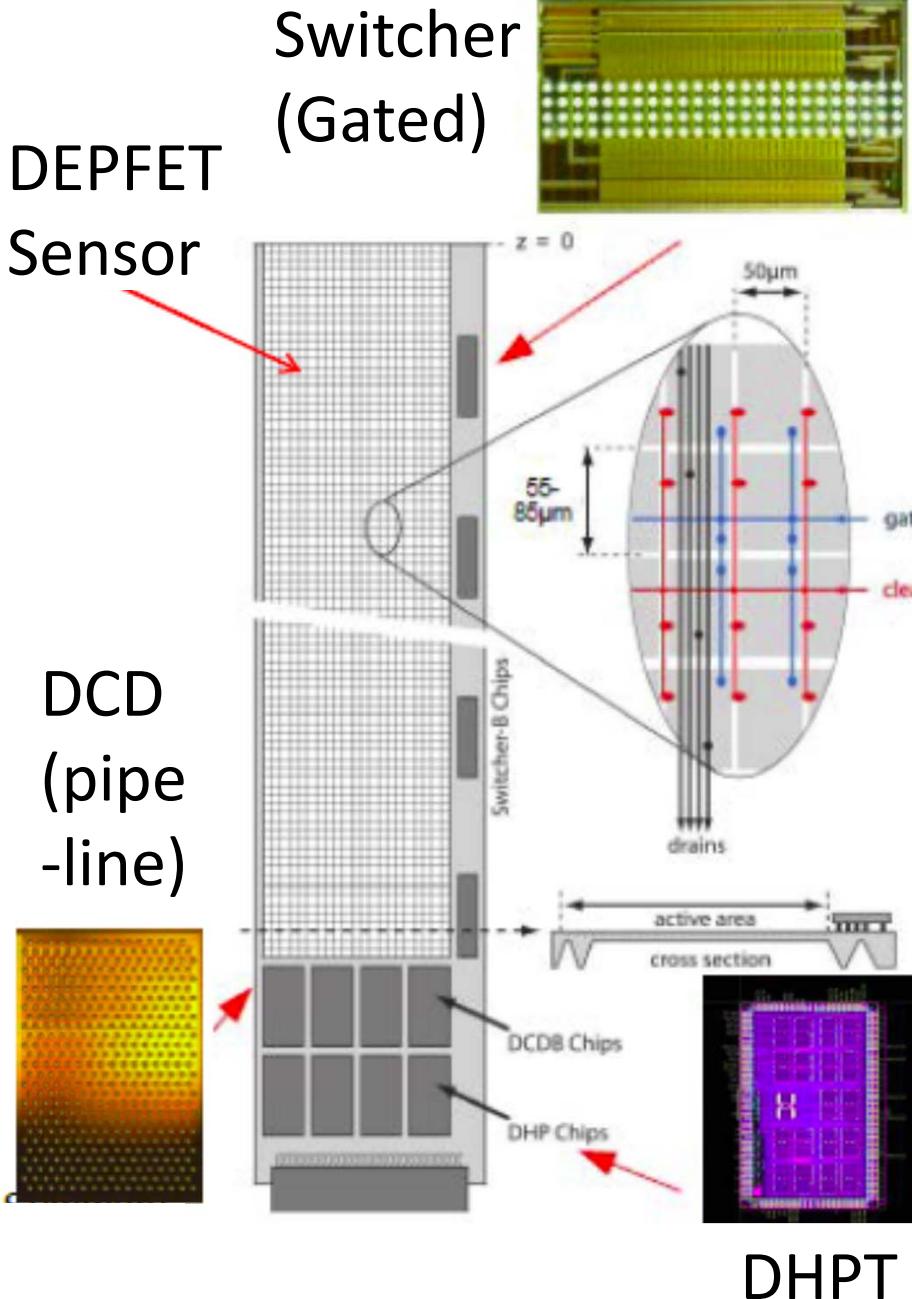
With some risk, we could decide to go ahead without full analysis of OF

Crucial: Time involved to get software / tuning fully working to repeat OB test





Final ASIC Production



DHPT 1.1 delivered, under test

Switcher delivered, back from bumping end of January

DCDBs (5 versions) submitted, expected back early February

Test preparation at KIT:

- Probe cards for new SWB and DCD under development
- Qualify present DCDs (for DESY test)

Realistic schedule needed !



Subjects to Address

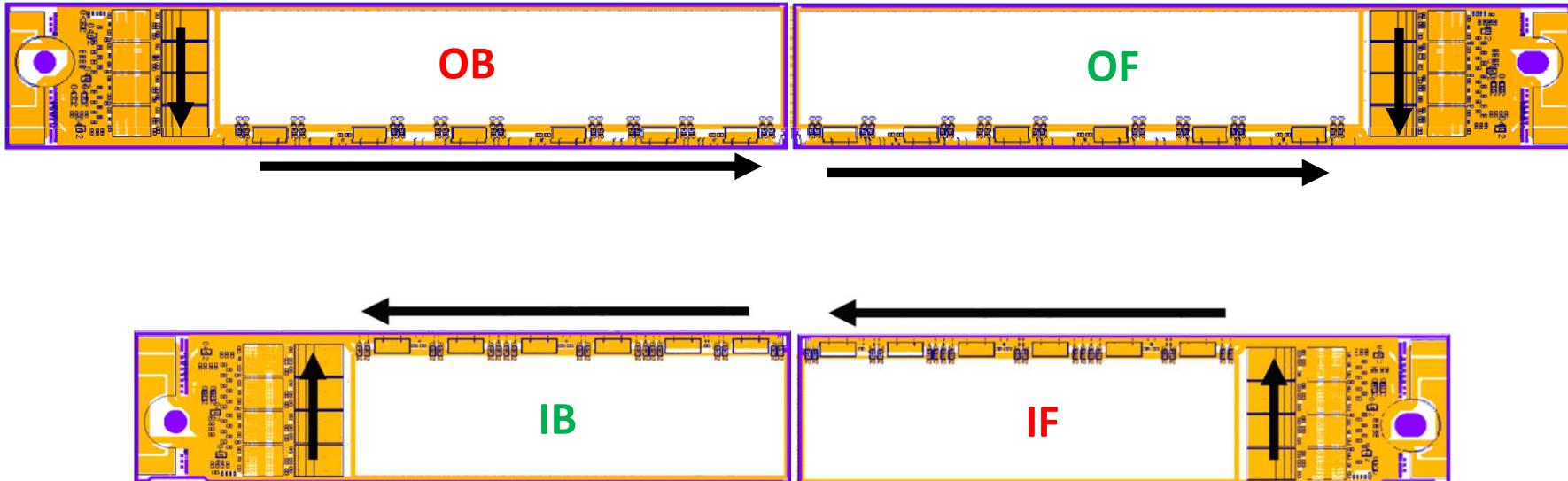


- ❖ Next step (after Green Light for Production): equip one / two modules (OF) with new DHPT + old SWB / DCD
- ❖ Preparation of DESY Test: old DCD, old Switcher, new DHPT for one / half ladder
 - other ladder: new SWB, old DCD
 - Gluing technology needs attention
- ❖ Have more groups involved in testing (-> training sessions at HLL)
MPI, Bonn, ?? Can provide 3 OF modules (with Kapton)
- ❖ After DESY Test: need to prepare for BEAST 2 -> schedule, manpower
- ❖ Certification of IBBelle and MARCO (designed for 110 Bar maximum pressure, KEK can certify only up to 80 Bar)
- ❖ German TÜV may (again) be a solution



PXD Modules: Parallelization of Tests

View from “outside”



View from “inside”

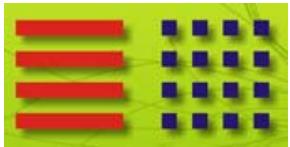
Pilot run yield: 14 of 18

2 IF	(2)	2 IB	(2)
6 OF	(5)	4 OB	(1)

Some (3) OF modules could be prepared with new DHPT for parallel testing in different groups

2 OB with Kapton, 1 broken
1 OF as Hybrid

(?): no ASICs / SMD yet



Near-term project (after start of metal1 structuring):

- Equip (1-2) sensors from pilot production with new DHPT, but “old” DCD and Switcher
- Continue testing entire matrix (all DHPT/DCD pairs working)

- Modules can be used for DESY test (gain time in ladder preparation for the DESY test, no performance loss due to fixed communication)

ASIC arrangement for the other DESY modules:

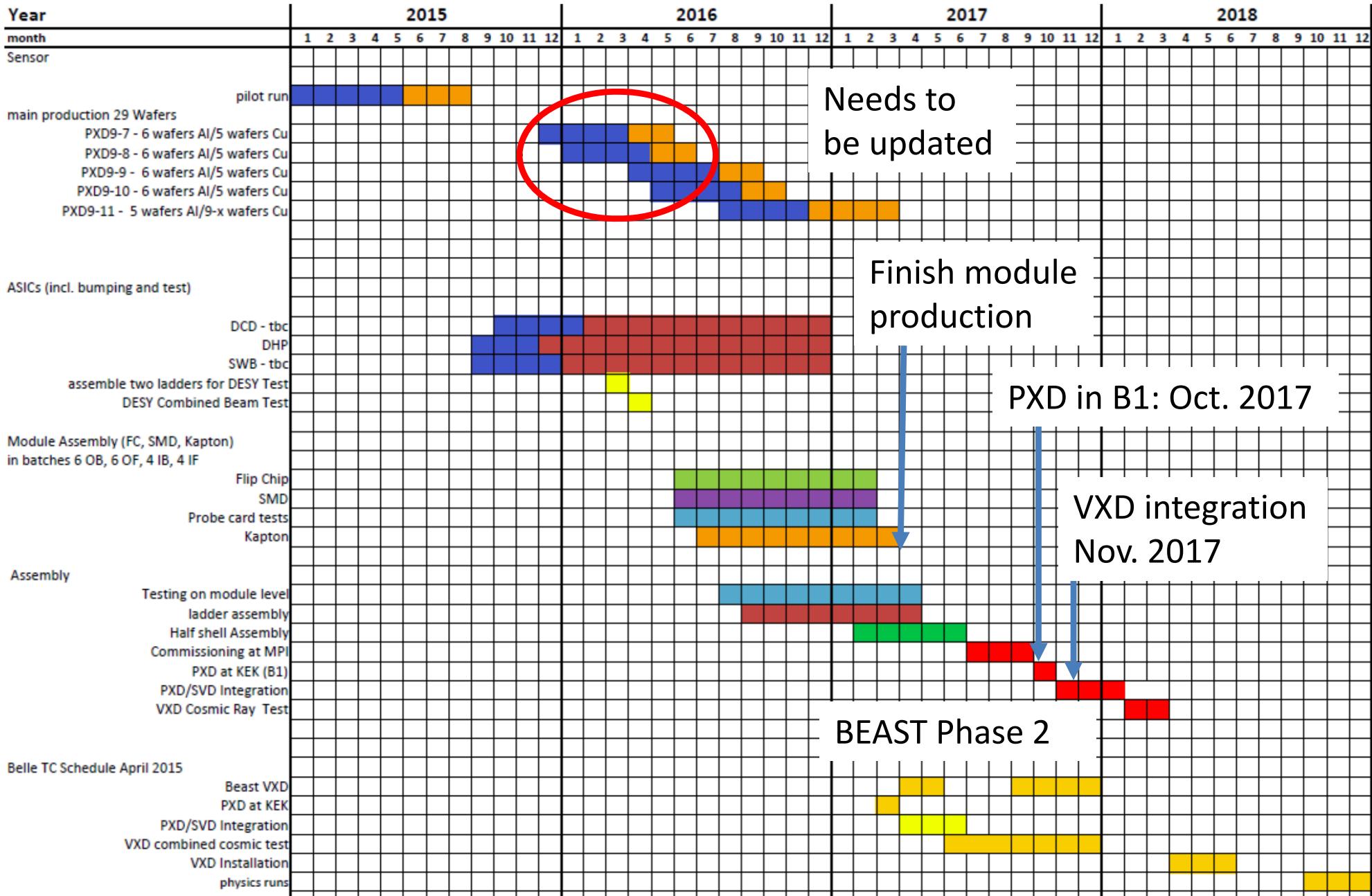
- new DHPT 1.1
- if new DCD not ready, take present DCD (works adequately)
- New Switcher needed, test setup being developed at KIT (this is critical, since too few “old” Switchers available)

Mechanical support / cooling being designed:

- SCBs mounted on metal ground plate
- Plate also holds the SVD cartridge



PXD Production Schedule: Needs Update





Accelerating the Production Schedule



Start of structuring the first metal layer delayed by about 4-6 weeks

Recovery of lost time possible by accelerating module assembly:

- send larger batches of sensors for ASIC flip-chipping
- 5 consecutive batches planned,
- could be reduced to 4 or even 3

Reason for present conservative planning:

- check (small) batches after return from FC to spot errors
- get some contingency in case of delays

Fewer batches (with larger number of sensors):

- no clearly visible disadvantages,
- IZM so far demonstrated excellent control of FC process



B2GM / BPAC Meetings @ KEK



Jan. 30: VXD Mechanics Meeting

Jan. 31: BEAST Meeting

Feb. 1.-5.: B2GM

Feb. 7.-9.: BPAC



B2GM Time Table

date		chair	start	talk	discussion	site	speaker	Kankyuu-honkan Kobayashi Hall	S-go-ken Seminar Hall	S-go-ken Meeting Room	2-go-ken Meeting Room (L)	2-go-ken Meeting Room (M)	Kankyuu-honkan Meeting Room 2	Kankyuu-honkan Meeting Room 1	S-325	S-425	Tsukuba B4 etc.
Feb. 1			8:30:00		0:30:00	registration (K)											
	B4e		9:00:00	0:25:00	0:10:00	Opening Remarks	T. Browder										
			9:35:00	0:10:00	0:10:00	Report from KEK management	K. Tokuhuku b6c										
			0:55:00	0:25:00	0:10:00	SuperKEKB status, schedule and plans	Y. Funakoshi b6c										
			10:30:00	0:30:00		break											
			11:00:00	1:30:00													
			12:30:00	1:00:00		Lunch											
			13:30:00														
			13:30:00	2:00:00													
			15:30:00														
			15:30:00	0:20:00		break											
			16:10:00														
			17:50:00	0:20:00		break											
			18:10:00														
			18:10:00	2:00:00													
			20:10:00														
Feb. 2			9:00:00	1:30:00													
			10:30:00														
			10:30:00	0:20:00		break											
			10:50:00														
			10:50:00	2:00:00													
			12:50:00														
			12:50:00	1:10:00		Lunch	PureCaI TF meeting over lunch										
			14:00:00														
			14:00:00	2:00:00													
			16:00:00														
			16:00:00	0:20:00		break											
			16:20:00														
			16:20:00	1:30:00		almost plenary session in parallel to physics, computing	Soft&Phys/Comp(1)										
			17:50:00	0:10:00													
			18:00:00	2:00:00		Party											
			20:00:00														
			20:00:00														
Feb. 3			9:00:00	1:30:00													
Integration day (gemba schwesere)			10:30:00														
			10:30:00	0:20:00		break											
			10:50:00														
			10:50:00	2:00:00				Software/physics									
			10:50:00	10:50>													
			12:50:00														
			12:50:00	1:10:00		Lunch											
			14:00:00														
			14:00:00	2:00:00													
			16:00:00					Data processing 14:00-16:00									
			16:00:00	0:20:00		break											
			16:20:00														
			16:20:00	2:00:00													
			18:20:00					Software/physics									
			18:20:00	0:20:00		break											
			18:40:00														
			18:40:00	2:00:00													
			20:40:00														
Feb. 4	B4e		9:00:00	0:12:00	0:03:00	Beam Pipe	S. Taneika										
			9:15:00	0:12:00	0:03:00	PXD	C. Kiesling										
			9:30:00	0:12:00	0:03:00	PXD ASIC	B4e										
			9:45:00	0:12:00	0:03:00	SVD	C. Schwanda										
			10:00:00	0:12:00	0:03:00	VXD thermal test	Hue Ye										
			10:15:00														
			10:15:00	0:30:00		break											
			10:45:00	0:25:00	0:05:00	Inner detector integration	S. Taneika										
			10:45:00														

Important interactions with SVD, DAQ, machine



BPAC Presentations (I)



Feb 07

08:30	01:00	00:00	Executive session (closed)	
09:30			Welcome, Key issues of the review	T. Browder, Y. Sakai, Y. Ushiroda
09:30			KEK project development, implementation, manpower and future	K. Tokushuku
09:30	00:10	00:05	Belle 1 Overview (pub., collab. etc)	L.Piilonen
09:45	00:20	00:10	B(s) decays & CPV	B.Pal
10:15	00:20	00:10	(Semi-)leptonic and EW decays	P.Goldenzweig
10:45	00:20		break	
11:05	00:20	00:10	Charm & hadron physics	Y.Kato
11:35	00:20	00:10	Dark sector, Y(5S/1S/2S)	I.Jaegle
12:05	00:15	00:10	Two-photon & tau physics	H.Nakazawa
12:30	00:10	00:10	Concluding remark (goal and plan for 2016)	K. Miyabayashi
12:50	01:10		Lunch	
14:00				
14:00	00:05	00:15	SuperKEKB/Belle II project global schedule	Y. Ushiroda, K. Akai
14:20	00:20	00:10	SuperKEKB accelerator overview	K. Akai
14:50	00:10	00:10	Beam pipe and shields around IR	S. Tanaka
15:10	00:10	00:10	Beam background	H. Nakayama
15:30	00:20		break	tbc
15:50	00:10	00:10	BEAST phase 1	S. Vahsen
16:10	00:10	00:10	BEAST phase 2	S. Vahsen
16:30				
16:30	00:20	00:15	Physics in phase 2 and 3	P. Urquijo
17:05				
17:05	00:30		Executive session (closed)	
17:35	00:30		summary discussion	
18:05	00:40		move to Okura	
18:45	00:05		contingency	
18:50	02:00		reception	
20:50				



BPAC Presentations (II)



Feb 08						
08:30	00:30	00:00	Executive session (closed)			
09:00	00:10	00:10	Belle II detector overview	P. Krizan		
09:20						
09:20	01:20		DAQ (Belle2link, ...)	R. Itoh et al.	tbc	
10:40						
10:40						
10:40						
10:40	00:20		break			
11:00						
11:00	00:15	00:10	Slow Control	M. Nakao		
11:25	00:15	00:10	Interlock	S. Uehara	tbc	
11:50	00:15	00:10	Level 1 Trigger	Y. Iwasaki	tbc	
12:15	00:10	00:10	GND/EMC	M. Tanaka		
12:35	01:10		Lunch			
13:45	02:20		gemba visit	I. Adachi, S. Tanaka et al.		
16:05	00:20		break			
16:25	00:25	00:10	KLM	D. Liventsev	tbc	
17:00	00:25	00:10	ECL	A. Kuzmin	tbc	
17:35	00:10	00:10	Endcap ECL upgrade	tba		
17:55						
17:55						
17:55	00:20		break (+snack)			
18:15			ARICH	S. Korpar, S. Nishida et	tbc	
18:15	00:25	00:10	ARICH status			
18:50	00:15	00:10	HAPD tests			
19:15						
19:15	00:30		Executive session (closed)			
19:45	00:30		summary discussion			
20:15						



BPAC Presentations (III)

Feb 09						
08:30	00:30	00:00	Executive session (closed)			
09:00	01:00		TOP	J. Fast et al.	tbc	
10:00	00:10	00:10	Magnetic field	C. Niebuhr	tbc	
10:20	00:25	00:10	CDC	S. Uno	tbc	
10:55	00:20		break			
11:15						
11:15	00:10	00:10	VXD mechanics	S. Tanaka		
11:35	00:15	00:10	VXD thermal management	C. Niebuhr	tbc	
12:00	00:10	00:10	CO2 cooling	C. Kiesling		
12:20	00:05	00:10	VXD integration plan	S. Tanaka		
12:35	01:10		Lunch			
13:45						
13:45						
13:45	01:40		PXD and PXD DAQ	C. Kiesling et al.	tbc	
15:25						
15:25						
15:25	00:20		break			
15:45						
15:45	00:40	00:40	SVD	C. Schwanda et al.	tbc	
17:05						
17:05						
17:05	00:20		break (+snack)			
17:25	01:30		Software, Computing	T. Kuhr, T. Hara et al.	tbc	
18:55						
18:55	01:00		Executive session (closed)			
19:55	00:30		Close out			
20:25						



BPAC Presentations (IV)



13:45

13:45 01:40

PXD and PXD DAQ

C. Kiesling et al.

tbc

15:25

What should be presented:

- Overview & Schedule
- Status of Test measurements -> start of metal 1 structuring
- Status of ASICs
- Module + Ladder Assembly / Test
- Thermal Mockup
- CO2 Cooling
- VXD Assembly and Commissioning
- VXD Installation
- Slow control / general reconstruction / monitoring software

8 Talks in 100 min -> 10 min each + 2.5 min discussion

4 (5) Talks -> 20 (15) min each and 5 min discussion



Common Fund founded in 2009

- Reason: Collect funds for cases of unforeseen expenditures
- Contributions done on the basis of DEPFET MoU
- Contributions are voluntary, account localized at MPI
- No yearly budgeting required (secure funds over fiscal year boundaries)
- Expenditures discussed / authorized in DEPFET IB Meeting
- Payment of bills authorized by PL



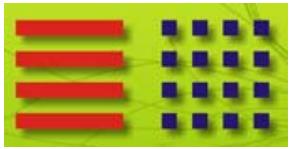
Overview DEPFET Common Fund

Year	Contribution [k€]	Institute	
2009	22,00	Prague	
2010	80,00	Prague	
	30,00	Prague	
	6,40	Prague	
	25,00	MPI	
2011	32,50	Prague	
2012	2,00	TUM	Conf
	66,00	Prague	
2013	100,00	MPI	
2014	4,50	German univ	Travel PL
	20,00	KEK	CO2
	6,00	Krakow	CO2
	5,00	Vienna	CO2
	20,00	INFN	CO2
2015	58,21	LMU (Rest of BMBF Money)	CO2
	23,21	Tabuk	CO2
	50,00	DESY	CO2
	20,00	HD Uni	Slow Control
	570,82		
Expenses (k€)		PXD only (not KEK-PF)	
Status ("Haben")	322,92		
	247,90		



DEPFET Common Fund Sub Accounts

		Expend (k€)
Grounding project ITA	A	52,19
KEK-PF	B	0,00 (in = out)
IBBelle (CO2)	C	172,67
Personnel + travel	D	98,06
Electronics (since 2016)	E	
		322,92



Backup

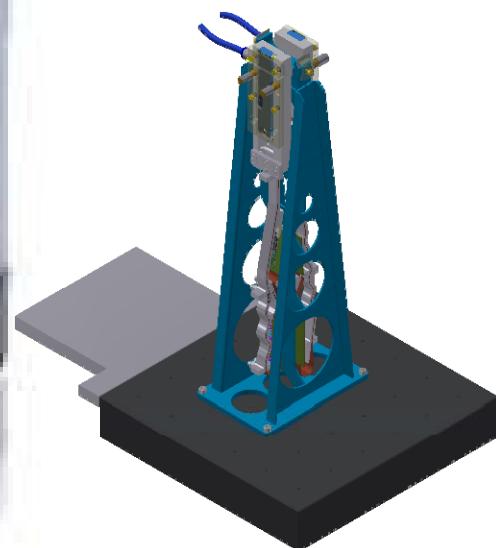


Ladder Production

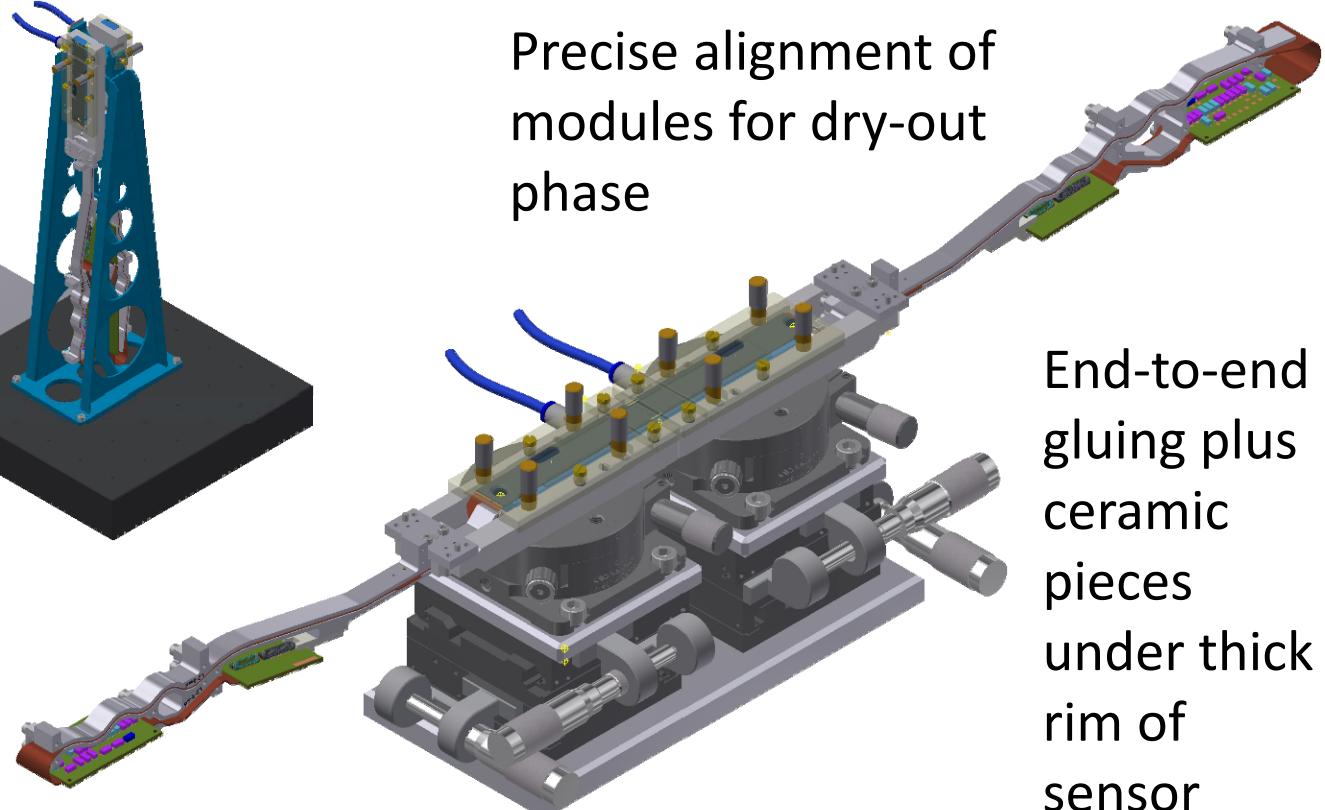
Concept for final production step: gluing of modules to sensors



Glue dispenser
(not to scale)



Tower holding 2
modules vertically
under dispenser



Precise alignment of
modules for dry-out
phase

End-to-end
gluing plus
ceramic
pieces
under thick
rim of
sensor